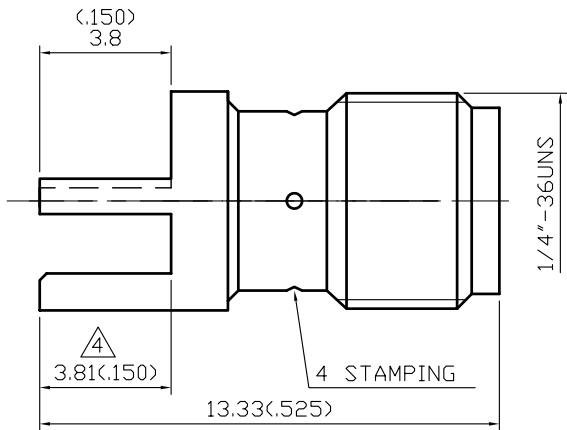
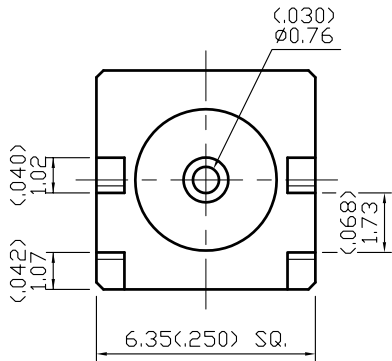


NO	DESCRIPTION	DATE
①	BACKGROUND FORMAT UPDATED	07.18.02
②	MODIFICATION FOR ①②③	04.03.03
③	MODIFICATION CENTER CONTACT ② INSULATION ③	05.04.05
④	⟨.015⟩ → ⟨.150⟩	06.22.05




NOTES: UNLESS OTHERWISE SPECIFIED

- 1. BODIES: BRASS PER JIS-C3604
- 2. CENTER CONTACT: BERYLLIUM COPPER PER ASTM B196 UNS C17300
- 3. INSULATION: TEFLON PER ASTM D1457 AND ASTM D1710
- 4. CONNECTOR INTERFACE PER MIL-STD-348A
- 5. PART TO BE CLEAN AND FREE OF BURRS

3	INSULATION	TEFLON	1	NONE
2	CENTER CONTACT	BERYLLIUM COPPER	1	GOLD 50 μ" MIN.
1	BODY	BRASS	1	GOLD 3 μ" MIN.
NO	DESCRIPTION	MATERIAL	Q' TY	FINISH

APPROVED

 by \_\_\_\_\_ DATE: \_\_\_\_\_

DESCRIPTION			SMA EDGE MOUNT JACK RECEPTACLE							
製圖	DRAWN	TOLERANCE		品名	19-70-1/ROHS COMPLIANT (50Ω)		日期	DATE	版次	REV.
	Nina			08.22.00				A-4		
檢圖	CHECK	.XX	±0.2	TITLE	DWG.NO. 19-0069					
	Lewis			UNIT mm(in)						
認定	APPROVAL	.XXX	±0.05	單位 比例	SCALE 6:1	<div> 佳楠精密電子股份有限公司 CHIN NAN PRECISION ELECTRONICS CO.,LTD.</div>				
	Lewis									